

Paste-type (Grease) Thermal Gel

# $\lambda$ GEL™ DP

◆ *Lambda GEL/DP* ◆

Fill gaps around the heat source for improved heat dissipation. Chemical bonds in the  $\lambda$ GEL eliminate running and vaporization problems.  $\lambda$ GEL DP is easily spread over heat generating devices.

$\lambda$ GEL™  
*Discover Softness.*

 **Taica**  
www.taica.co.jp

### About λGEL DP series

- ◆ λGEL DP series are very soft paste-type (grease) gel with heat conducting properties.
- ◆ Cross-linked particles of the λGEL eliminate running and vaporization seen with other traditional grease and phase change materials.
- ◆ DP-100, -200, and -300 products have better conductive properties than standard grease.
- ◆ λGEL DP series have very high specific volume resistance ratio up to  $7.2 \times 10^{14} \cdot \Omega \cdot \text{cm}$ .
- ◆ λGEL DP series have high breakdown voltage characteristics up to 9.6 kV/mm
- ◆ λGEL DP series have a very low dissipation factor down to 0.0004 at 1MHz.
- ◆ REP-100 is very soft paste-type gel with electromagnetic noise absorption property.

### Specifications

Item	Paste-type Thermal Gel DP Series				Remark	
	DP-100	DP-200	DP-300	EMI absorbent + Thermal Conductive Gel REP-100		
Thermal conductivity (W/m·K)	Our tests	6.5	4.8	4.8	1.0	Getlec std.
	Hot Wire Method ※1	2.1	1.6	1.6	0.6	JIS R 2616
Appearance	Gray paste	Gray paste	White paste	Black	—	—
Specific gravity	2.8	2.6	2.7	2.9	—	JIS K 6249
Hardness (Cone penetration · 1/10mm not mixed)	51	55	60	60	—	JIS K 6249 (1/4cone)
Specific volume resistance ratio ( $\Omega \cdot \text{cm}$ )	$5.9 \times 10^{13}$	$7.2 \times 10^{14}$	$1.4 \times 10^{14}$	$2.0 \times 10^{11}$	—	JIS K 6249
Dielectric constant	<50Hz	8.9	7.6	4.4	—	JIS K 6249
	<1kHz	7.8	6.7	4.2	—	JIS K 6249
	<1MHz	7.0	6.6	4.0	—	JIS K 6249
Dielectric dissipation factor	<50Hz	0.234	0.017	0.005	—	JIS K 6249
	<1kHz	0.061	0.007	0.004	—	JIS K 6249
	<1MHz	0.015	0.005	0.0004	—	JIS K 6249
Dielectric breakdown voltage (kV/mm)	5.0	5.6	9.6	4.0	—	JIS K 6249
Low molecular weight siloxane level ΣD4-10 (ppm)	Solvent extraction method	less than 700	less than 900	less than 300	less than 300	—
	Head space Method ※2	less than 1	less than 3	less than 1	less than 1	—
RoHS controlled substances ※3	Not detected	Not detected	Not detected	Not detected	—	—
Temperature range (°C) ※4	-40~+200	-40~+150	-40~+120	-40~+150	—	—
			Bottle	Bottle		

※1 Hot Wire Method : Using the QTM -500 Quick Thermal Conductivity Meter, from Kyoto Electronics Manufacturing Co., LTD.

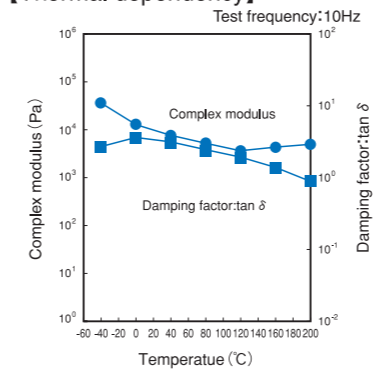
※2 Head Space Method : at 70°C

※3 RoHS controlled substances : Assayed by SGS Far East Ltd.

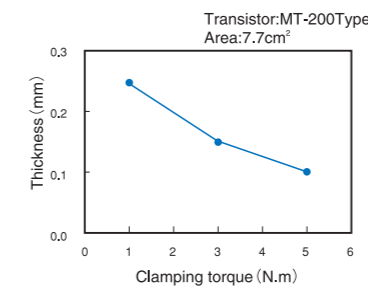
※4 Temperature range : These temperature ranges are not the guaranteed values by Taica Corporation  
The applicability should be determined respectively through the tests under actual conditions of each usage.

### DP-100

#### 【Thermal dependency】



#### 【Clamping torque dependency】

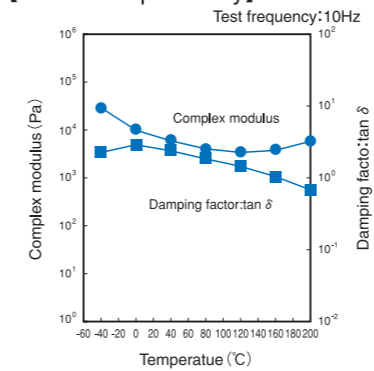


#### 【Thermal resistance】

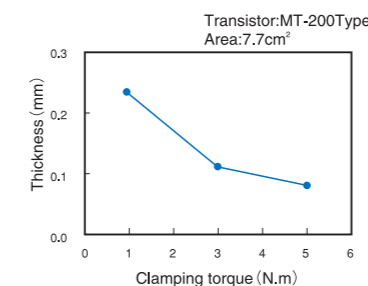
Transistor: MT-200Type Heat input: 20W			
Thickness (mm)	0.15	0.2	0.3
Thermal resistance (°C/W)	0.13	0.15	0.18

### DP-200

#### 【Thermal dependency】



#### 【Clamping torque dependency】

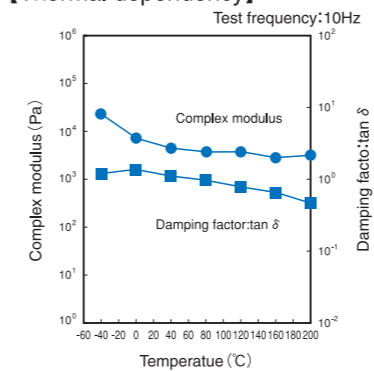


#### 【Thermal resistance】

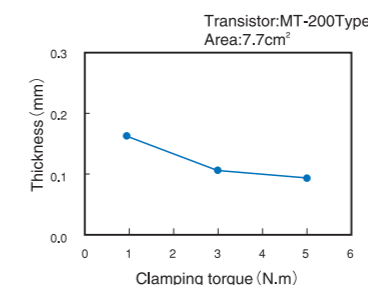
Transistor: MT-200Type Heat input: 20W			
Thickness (mm)	0.1	0.2	0.3
Thermal resistance (°C/W)	0.13	0.17	0.22

### DP-300

#### 【Thermal dependency】



#### 【Clamping torque dependency】

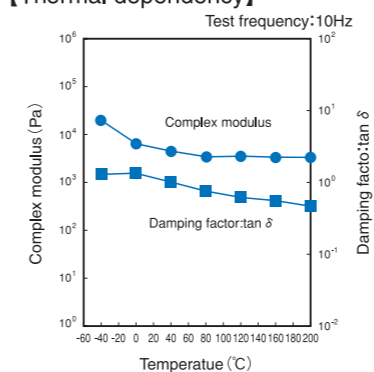


#### 【Thermal resistance】

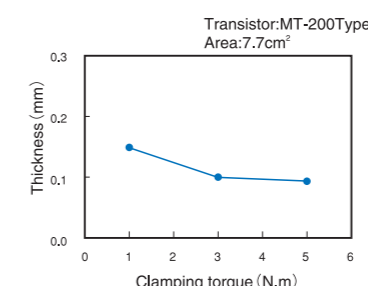
Transistor: MT-200Type Heat input: 20W			
Thickness (mm)	0.1	0.2	0.3
Thermal resistance (°C/W)	0.09	0.17	0.25

### REP-100

#### 【Thermal dependency】



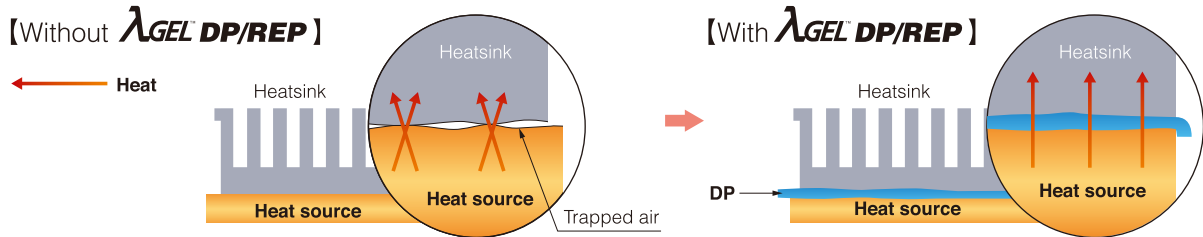
#### 【Clamping torque dependency】



#### 【Thermal resistance】

Transistor: MT-200Type Heat input: 20W			
Thickness (mm)	0.1	0.2	0.3
Thermal resistance (°C/W)	0.22	0.36	0.50

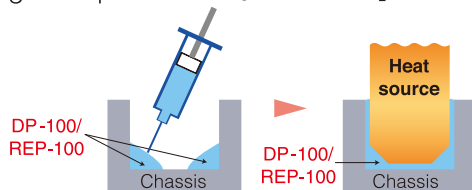
## The flow of heat



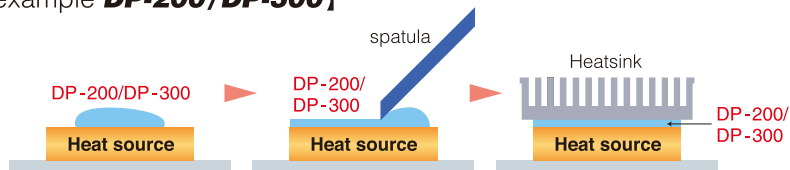
## Suggested uses

- Gaps around heat sources such as high performance semiconductors
- The surface, underside, and lead lines of heat sources such as ICs.
- Sources of heat where it is difficult to fix sheet-type thermal gel.
- Where there is insufficient room for thermal conductive material.

### 【Filling example DP-100/REP-100】



### 【Coating example DP-200/DP-300】



## Delivery format

### 【Basic specifications】

DP-100,200	Syringe	30cc
DP-300,REP-100	Bottle	30cc

Other package is also available.



## Note

- ◆Silicone oil may bleed under certain usage condition.
  - ◆Low molecular siloxane is included in this product which basically composed of silicone.
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